

**REAL TIME CLOCK MODULE (SPI-Bus)
LOW BACKUP VOLTAGE**



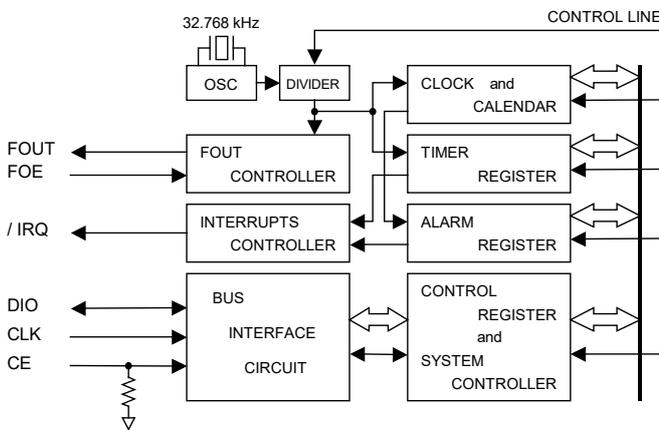
Product Number
RX-4571LC : Q414571C2000100
RX-4571SA : Q41457152000100

RX-4571LC / SA

- Built in frequency adjusted 32.768 kHz crystal unit.
- Interface Type : 3-wire serial interface
- Operating voltage range : 1.6 V to 5.5 V
- The wide voltage for time keeping. : 1.0 V to 5.5 V / T_a = +25 °C
- Low backup current : 0.32 μA (Typ.) / 3 V
- 32.768 kHz frequency output function : C-MOS output With OE pin.
- Real-time clock function
 Clock/calendar function, auto leap year correction function, alarm and Timer interrupt function, etc.



Block diagram



Overview

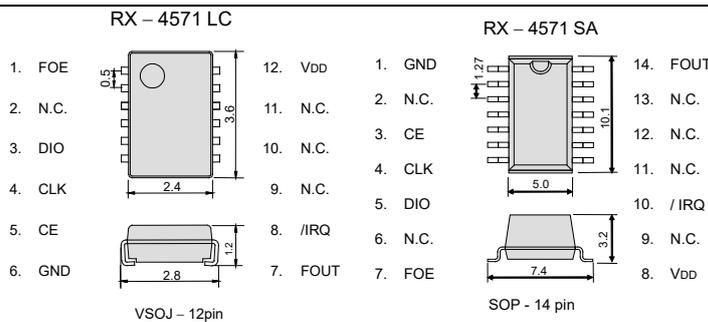
- **32.768 kHz frequency output function**
 - FOUT pin output (C-MOS output), CL=30 pF
- **Timer function**
 - Timer function which can be set up between 1/4096 second and 4095 minutes.
- **Alarm function**
 - Alarm function can be set to any combination of day, day of week, hour, or minute.

Pin Function

Signal Name	Input / Output	Function
CE	Input	The chip enabled input pin 0. (It has a built -in pull-down resistance)
CLK	Input	The shift clock input pin for serial data transfer.
DIO	Bi-directional	The data input / output pin for serial data transfer.
FOUT	Output	32.768 kHz clock output pin with the output control function. (C-MOS)
FOE	Input	FOE pin control the condition of FOUT with FSEL1-bit, FSEL0-bit, etc.
/ IRQ	Output	Interrupt output (N-ch open drain)
VDD	—	Connected to a positive power supply.
GND	—	Connected to a ground.

Terminal connection / External dimensions

(Unit:mm)



***Stop using the glue**
 Any glue must never use it after soldering LC-package to a circuit board. This product has glass on the back side of a package. When glue invasions between circuit board side and glass side, then glass cracks by thermal expansion of glue. In this case a crystal oscillation stops. Consider glue abolition or glue do not touch to LC-package

The metal case inside of the molding compound may be exposed on the top or bottom of this product. This purely cosmetic and does not have any effect on quality, reliability or electrical specs.

Specifications (characteristics)

* Refer to application manual for details.

Recommended Operating Conditions

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Power voltage	VDD	—	1.6	3.0	5.5	V
Clock voltage	VCLK	T _a = +25 °C	1.0	3.0	5.5	V
		T _a = -40 to +85 °C	1.1	3.0	5.5	V
Operating temperature	T _{OPR}	—	-40	+25	+85	°C

Frequency characteristics

Item	Symbol	Conditions	Rating	Unit
Frequency tolerance	Δ f / f	T _a = +25 °C VDD = 3.0 V	B: 5 ± 23 *	× 10 ⁻⁶
Oscillation start-up time	t _{STA}	T _a = +25 °C VDD = 1.6 V	1 Max.	s

* Please ask for tighter tolerance. (Equivalent to ±1 minute of monthly deviation)

Current consumption characteristics

T_a = -40 °C to +85 °C

Symbol	Conditions	Min.	Typ.	Max.	Unit	
I _{BK}	CE = GND /IRQ = OFF	VDD = 5 V	-	0.40	1.00	μA
	FOUT ; output OFF (Hi - z)	VDD = 3 V	-	0.32	0.95	
I _{32k}	CE = GND /IRQ = OFF	VDD = 5 V	-	8.0	14.0	μA
	FOUT ; 32.768 kHz output ON CL = 30 pF	VDD = 3 V	-	5.0	8.5	

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

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► Explanation of the mark that are using it for the catalog

	► Pb free.
	► Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
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